V4P22C

Vishay General Semiconductor

High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.58$ V at $I_F = 1$ A

eSMP[®] Series

www.vishay.com



SMPC (TO-277A)

K → Anode 1 Cathode → Anode 2

ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 x 2.0 A			
V _{RRM}	200 V			
I _{FSM}	60 A			
V_F at $I_F = 2 A$	0.65 V			
T _J max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Common cathode			

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V4P22C	UNIT	
Device marking code		V422C		
Maximum repetitive peak reverse voltage	V _{RRM}	200	V	
Maximum average forward rectified current per device (fig. 1)	I _{F(AV)} ⁽¹⁾	4.0	— A	
	I _{F(AV)} ⁽²⁾	2.8		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	60	A	
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

⁽¹⁾ Mounted on 30 mm x 30 mm pad areas aluminum PCB

⁽²⁾ Free air, mounted on recommended pad area

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{0JA}

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HALOGEN

FREE

V4P22C



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ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I _F = 1 A	T _A = 25 °C	V _E (1)	0.74	-	V	
	I _F = 2 A			0.79	0.87		
	I _F = 1 A	T _A = 125 °C		VF ()	V _F (1) 0.58	-	v
	I _F = 2 A			0.65	0.73		
Reverse current per diode	$V_{R} = 160 V \qquad \frac{T_{A} = 25 \degree C}{T_{A} = 125 \degree C}$		0.001	-			
		T _A = 125 °C	I _R ⁽²⁾	0.3	-	mA	
	V _B = 200 V	T _A = 25 °C		-	0.05		
	v _R = 200 v	T _A = 125 °C		0.7	3		
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	125	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 $\,\%$ duty cycle

 $^{(2)}$ Pulse test: pulse width $\leq 40\ ms$

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified)					
PARAMETER	SYMBOL	UNIT			
Typical thermal resistance per device	R _{0JA} ⁽¹⁾⁽²⁾	85	°C/W		
	R _{0JM} ⁽³⁾	5	0/10		

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB, thermal resistance R_{0JA} - junction-to-ambient

⁽³⁾ Units mounted on 30 mm x 30 mm aluminum PCB, thermal resistance $R_{0,IM}$ - junction-to-mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V4P22C-M3/H	0.10	Н	1500	7" diameter plastic tape and reel		
V4P22C-M3/I	0.10	I	6500	13" diameter plastic tape and reel		
V4P22CHM3/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel		
V4P22CHM3/I (1)	0.10	I	6500	13" diameter plastic tape and reel		

Note

⁽¹⁾ AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

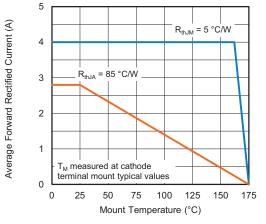


Fig. 1 - Maximum Forward Current Derating Curve

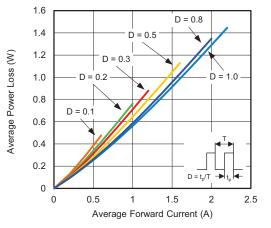


Fig. 2 - Forward Power Loss Characteristics Per Diode

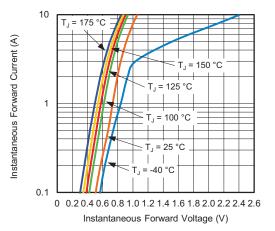


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

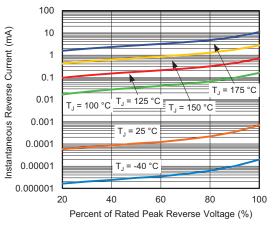


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

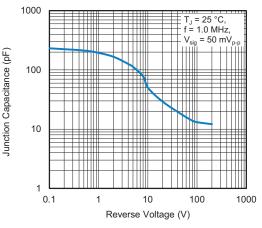
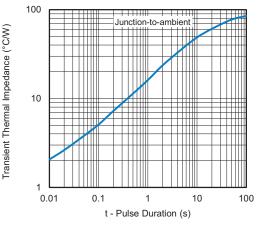


Fig. 5 - Typical Junction Capacitance Per Diode





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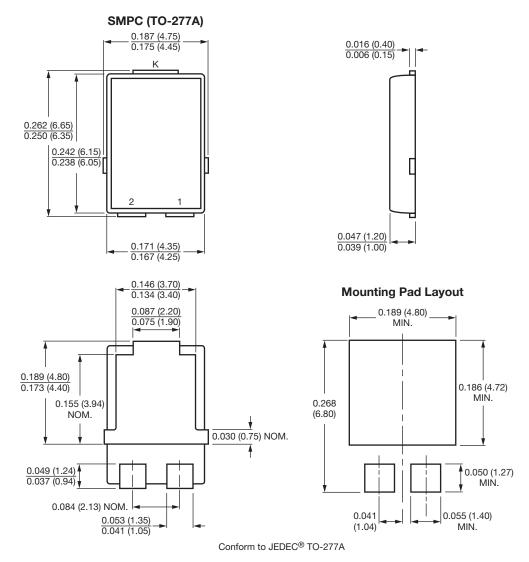
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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